

FIG. 3

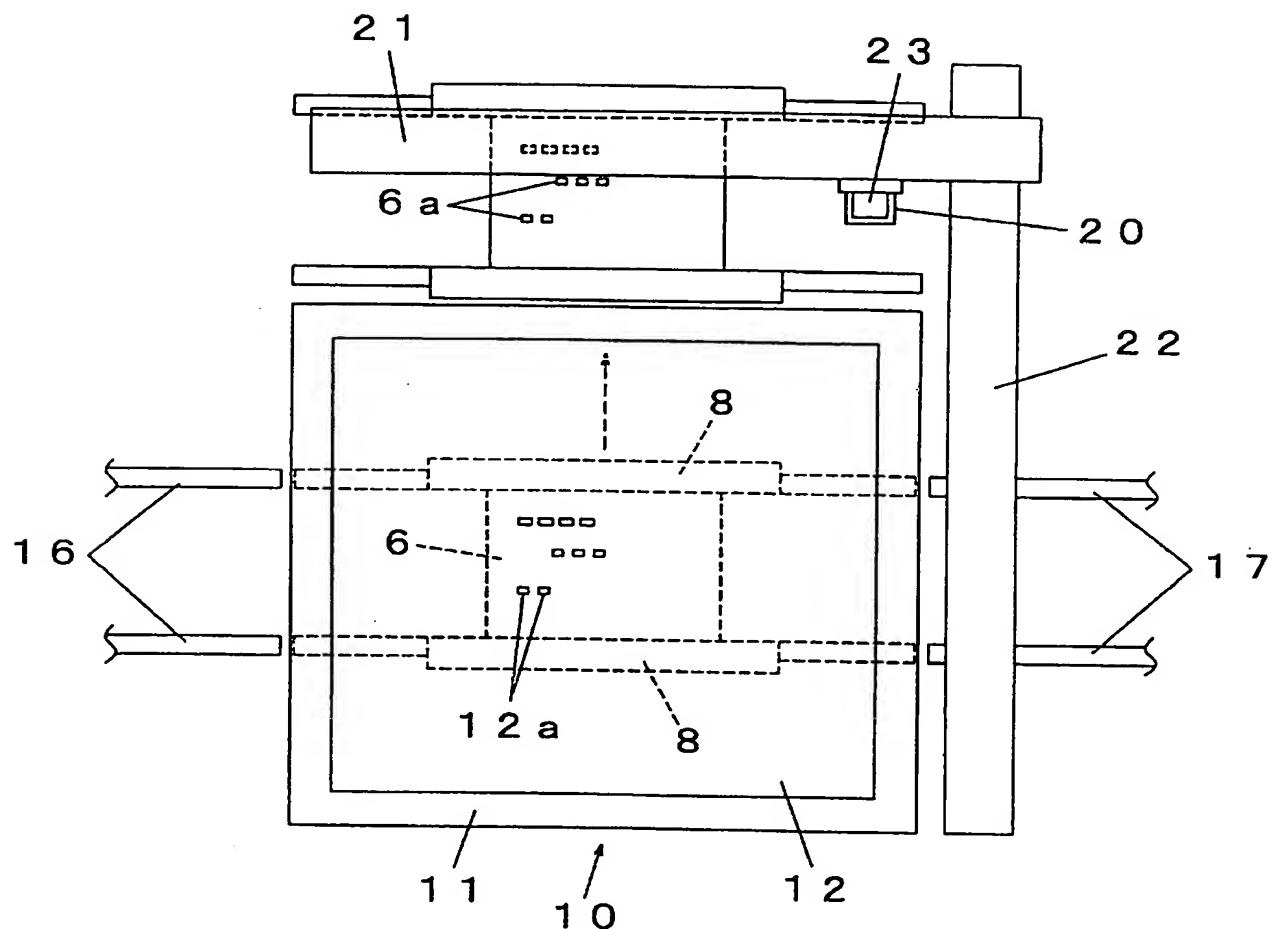


FIG. 4

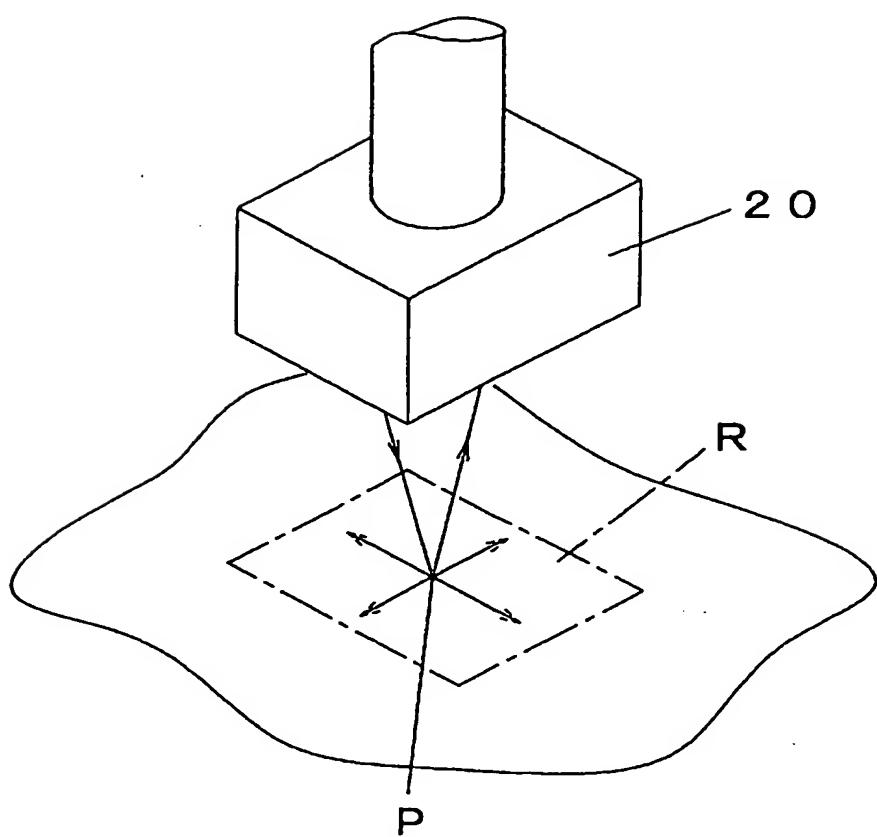


FIG. 5

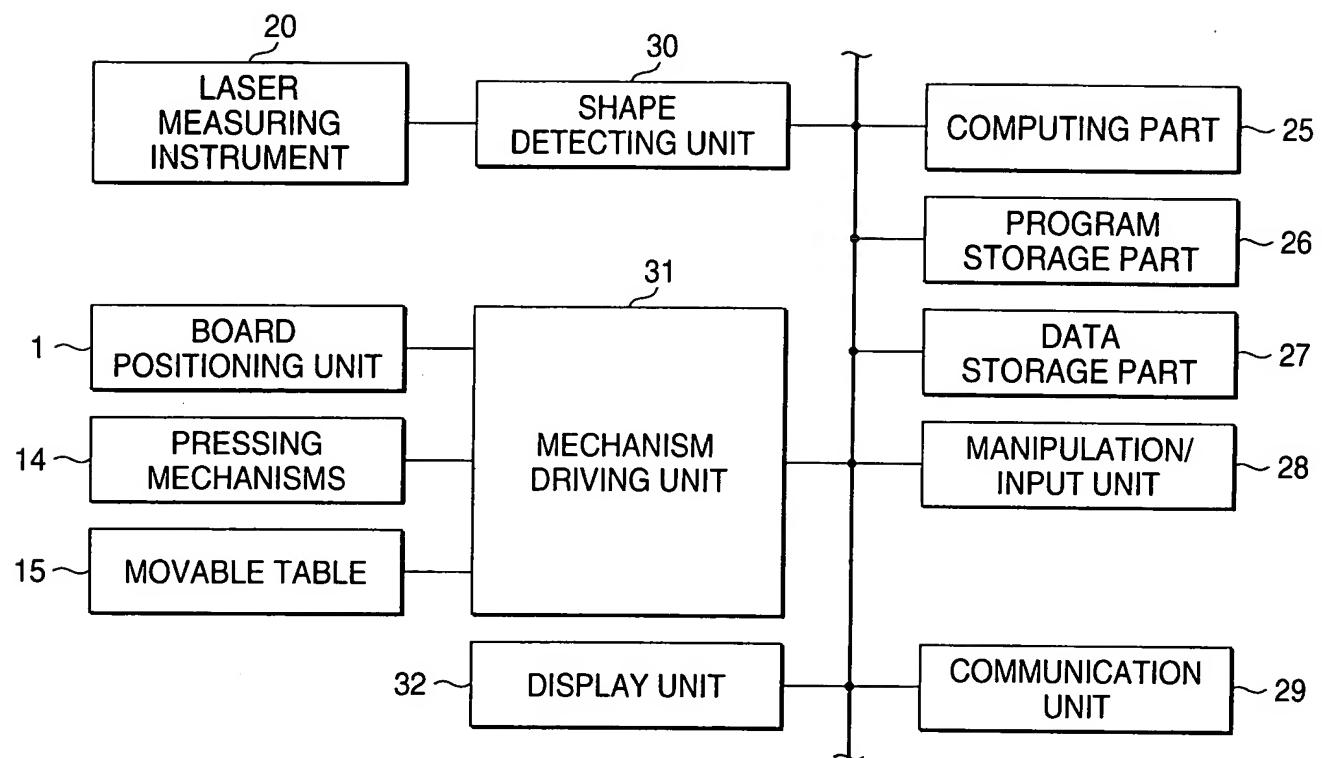


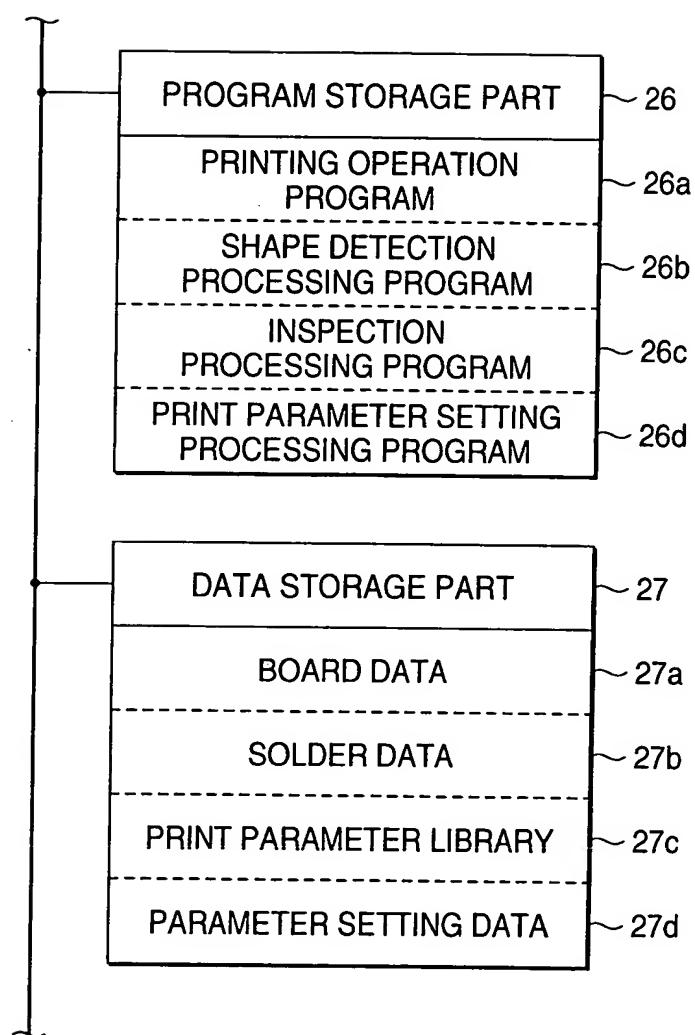
FIG. 6

FIG. 7

PATTERN NAME	A	B	C	
SOLDER TYPE PARAMETER	S1	S2	S3	
SQUEEGEE MOVEMENT SPEED	V1	V2	V3	
PRINTING PRESSURE	P1	P2	P3	
PLATE RELEASE PATTERN	I	II	III	
PLATE RELEASE SPEED	v1	v2	v3	

FIG. 8

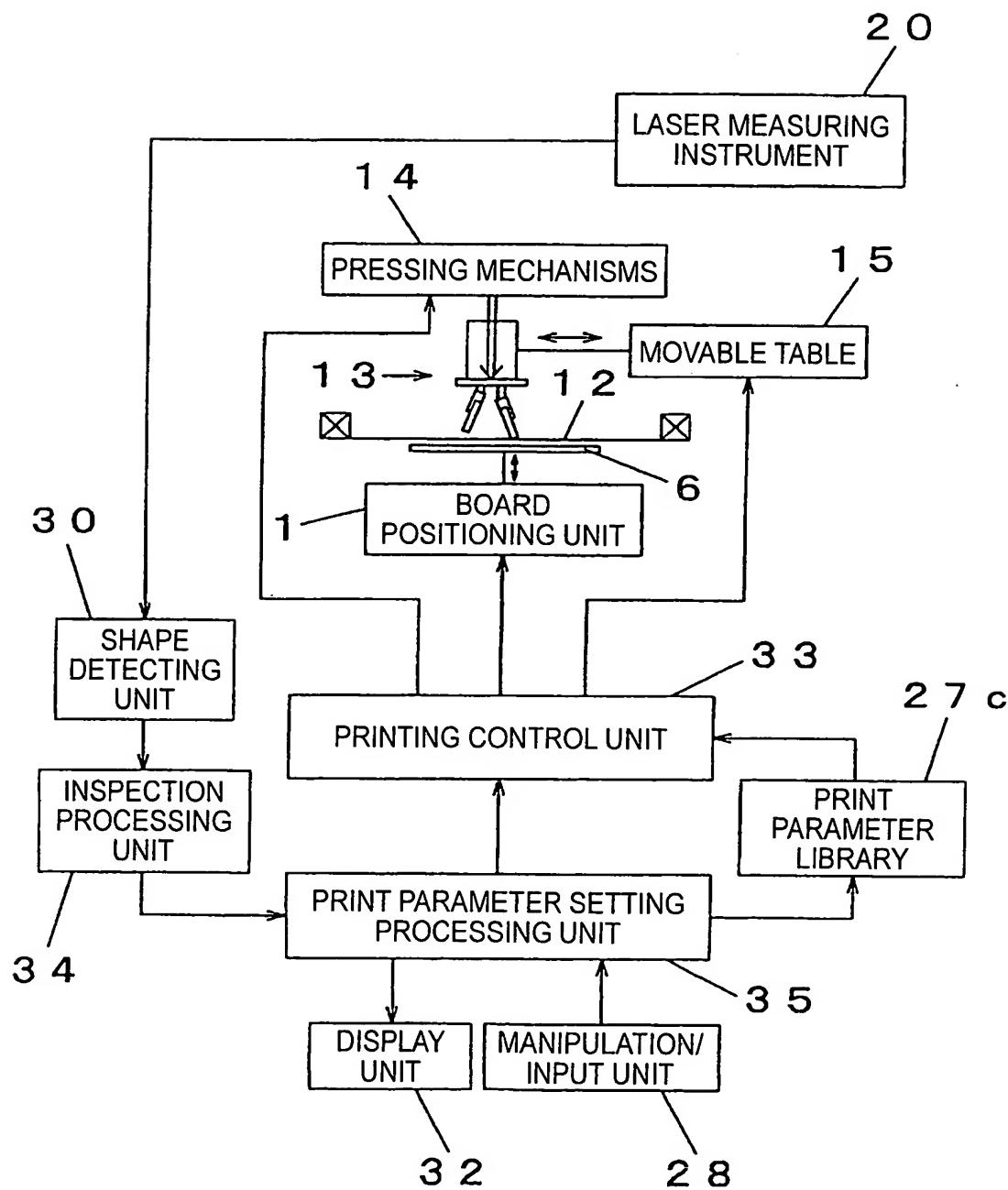


FIG. 9

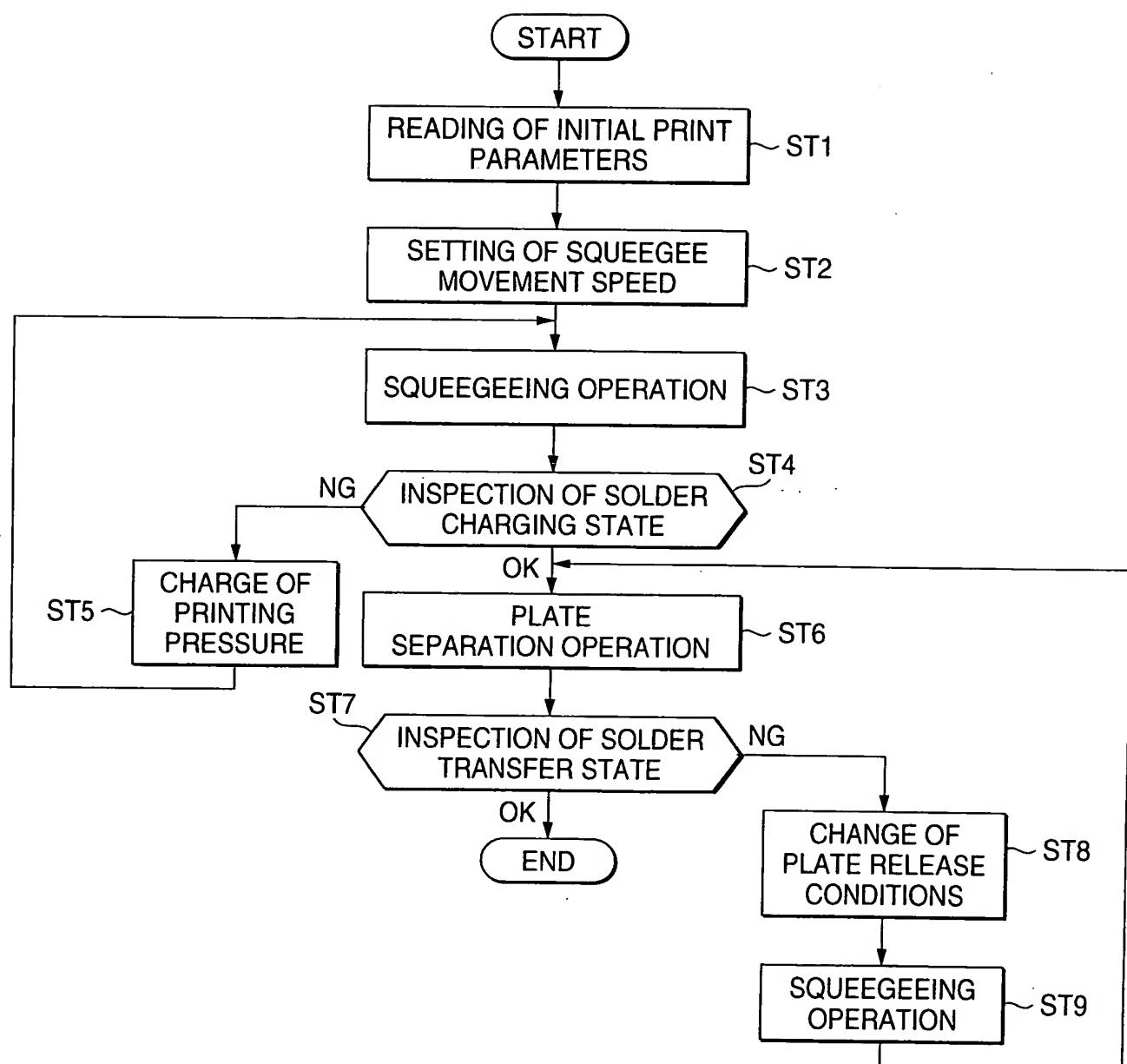


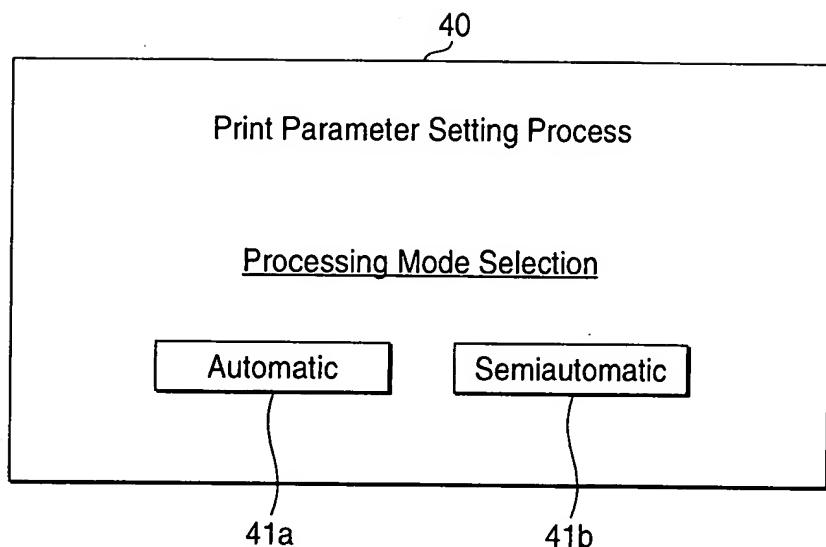
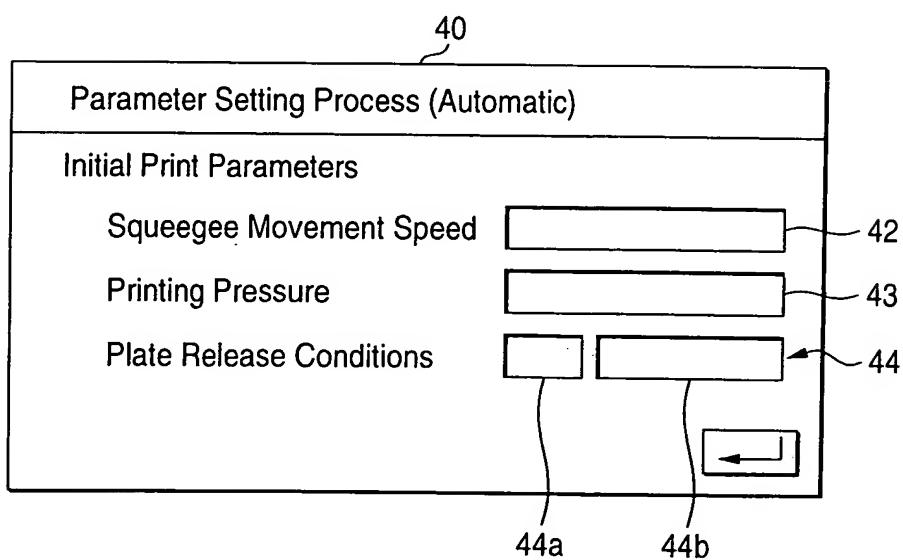
FIG. 10 (a)*FIG. 10 (b)*

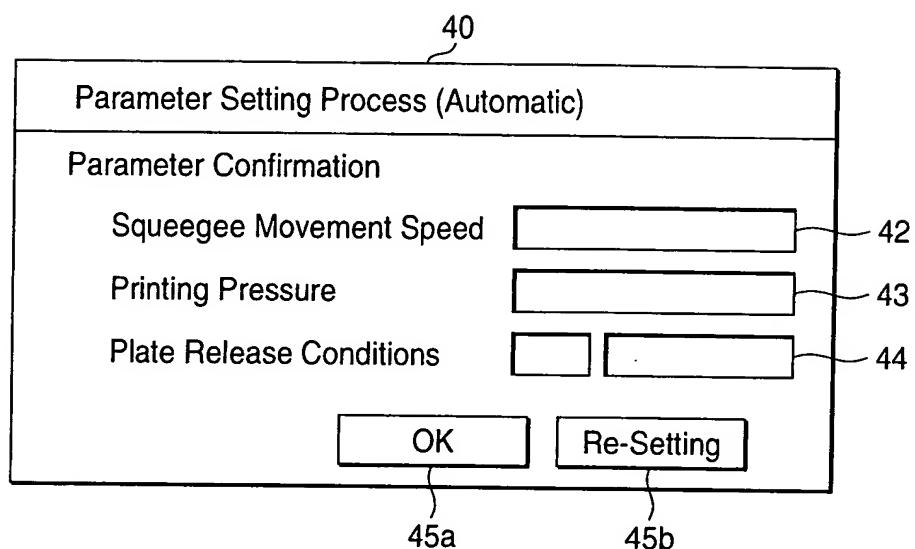
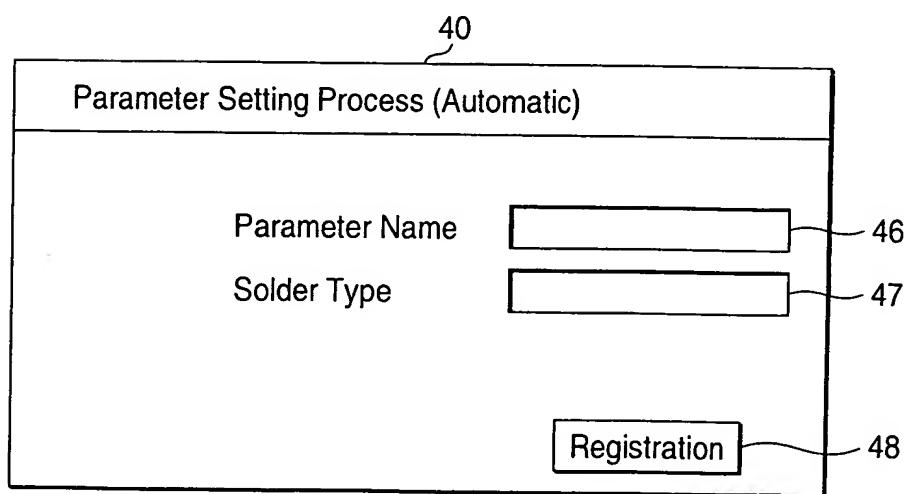
FIG. 11 (a)*FIG. 11 (b)*

FIG. 12

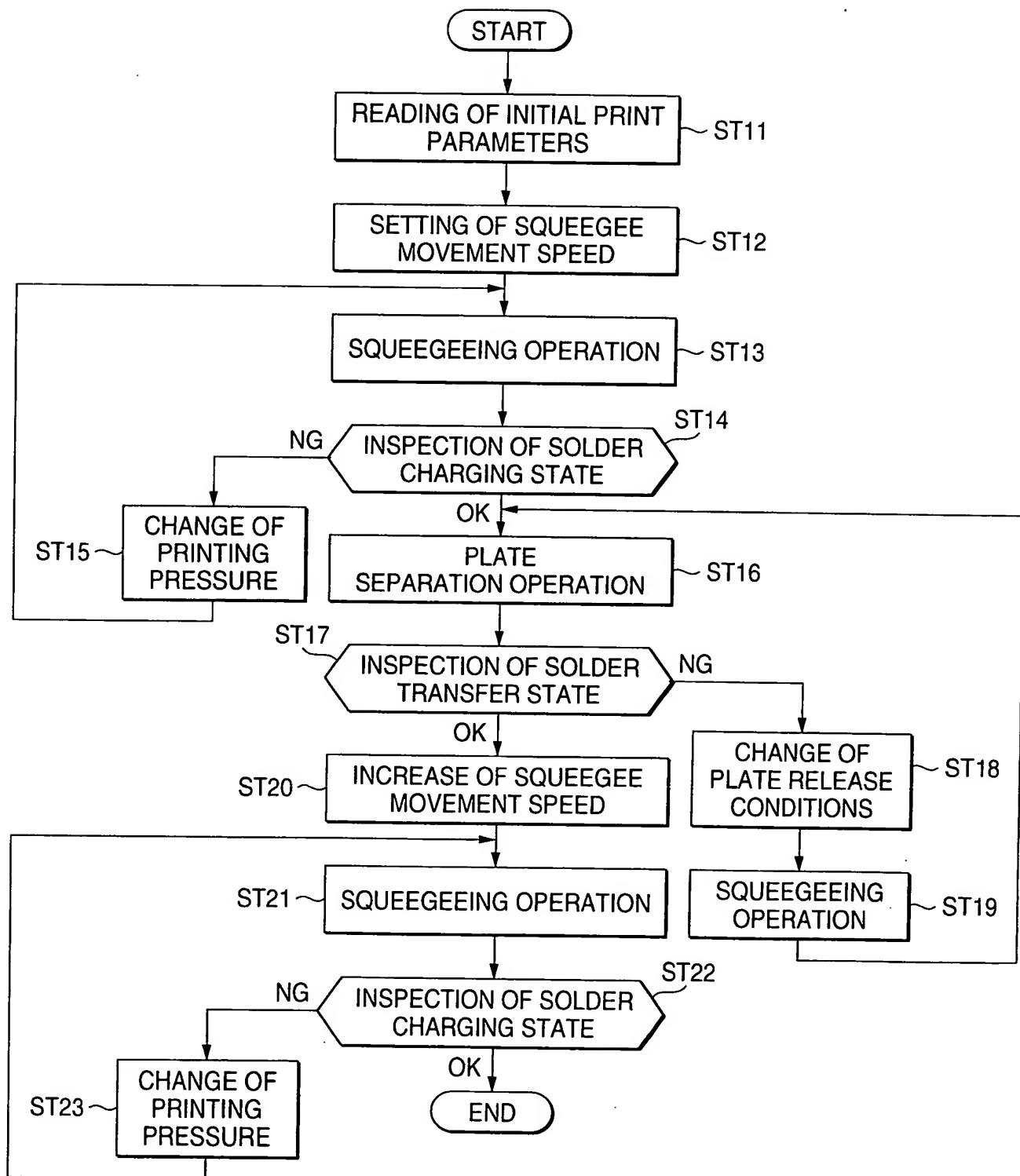
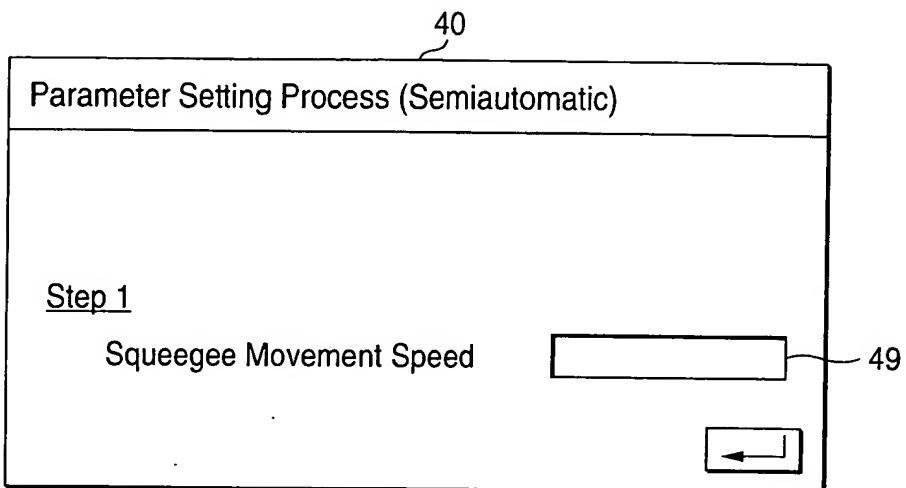
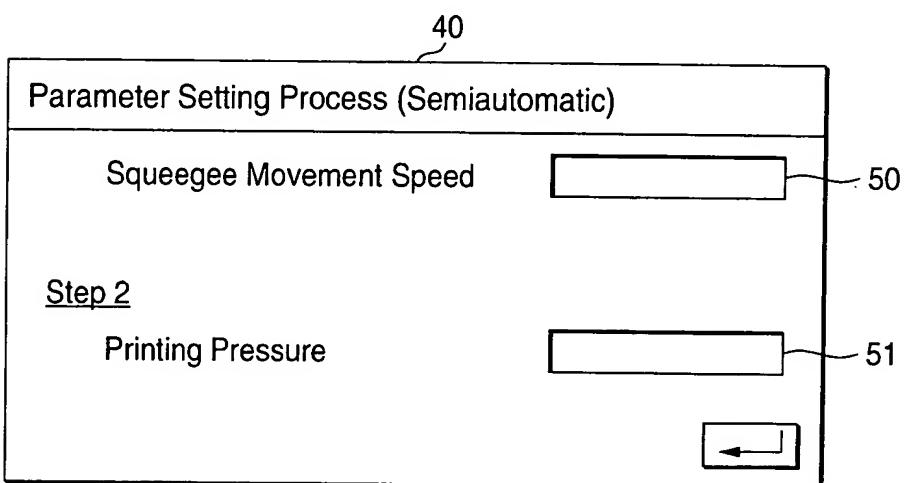


FIG. 13 (a)**FIG. 13 (b)****FIG. 13 (c)**